Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S2	7	((YOSHIKI) near2 (SAWAKI)).INV.	US-PGPUB; USPAT; USOCR	AND	ON	2008/01/24 08:35
S1	46	((MASANORI) near2 (AKITA)).INV.	US-PGPUB; USPAT; USOCR	AND	ON	2008/01/24 08:35
S3	46	S1 S2	US-PGPUB; USPAT; USOCR	OR	ON	2008/01/24 08:36
S4	4	("20020019066" "20020004250" "5768776" "6378774").did.	US-PGPUB; USPAT; USOCR	OR	ON	2008/01/24 08:37
S5	54	(((semiconductor or interposer) near2 (package or board)) with ((cut or cutting) (tape))) (electrode near5 tape)	US-PGPUB; USPAT; USOCR	AND	ON	2008/01/24 12:53
S6	53	(((semiconductor or interposer) near2 (package or board)) with (cut or cutting)) ((carrier or taansfer\$4 or adhesive) near2 tape) (electrode near5 tape)	US-PGPUB; USPAT; USOCR	AND	ON	2008/01/24 13:03
S7	33	(((semiconductor or interposer) near2 (package or board)) with (cut or cutting)) ((carrier or transfer\$4 or adhesive) near2 tape) (electrode near5 tape) (tape with peel\$3)	US-PGPUB; USPAT; USOCR	AND .	ON	2008/01/24 13:10
S9	18	((exfoliate) near5 tape)	US-PGPUB; USPAT; USOCR	AND	ON	2008/01/24 13:15
S8	1	((exfoliate adj layer) near5 tape)	US-PGPUB; USPAT; USOCR	AND	ON	2008/01/24 13:15
S10	. 1	((exfoliate adj layer) near5 tape)	US-PGPUB; USPAT; USOCR	AND	ON	2008/01/24 13:21
S11	1	((exfoliate\$1 adj (layer or surface)) near5 tape)	US-PGPUB; USPAT; USOCR	AND	ON	2008/01/24 13:24
S12	2797	(exfoliate\$1 near5 (layer or surface or film or tape))	US-PGPUB; USPAT; USOCR	AND	ON .	2008/01/24 13:25
S17	1	S12 (S15 or S16)	US-PGPUB; USPAT; USOCR	AND	ON	2008/01/24 13:26

S16	33	(((semiconductor or interposer) near2 (package or board)) with (cut or cutting)) ((carrier or transfer\$4 or adhesive) near2 tape) (electrode near5 tape) (tape with peel\$3)	US-PGPUB; USPAT; USOCR	AND	ON	2008/01/24 13:26
S15	53	(((semiconductor or interposer) near2 (package or board)) with (cut or cutting)) ((carrier or taansfer\$4 or adhesive) near2 tape) (electrode near5 tape)	US-PGPUB; USPAT; USOCR	AND	ON	2008/01/24 13:26
S14	1	S12 S13	US-PGPUB; USPAT; USOCR	AND	ON	2008/01/24 13:26
S13	54	(((semiconductor or interposer) near2 (package or board)) with ((cut or cutting) (tape))) (electrode near5 tape)	US-PGPUB; USPAT; USOCR	AND	ON .	2008/01/24 13:26
S19	93	S12 S18	US-PGPUB; USPAT; USOCR	AND	ON	2008/01/24 13:27
S18	32457	((semiconductor or interposer) near2 (package or board))	US-PGPUB; USPAT; USOCR	AND	ON	2008/01/24 13:27
S22	. 1	S19 (electrode near5 tape)	US-PGPUB; USPAT; USOCR	AND	ON	2008/01/24 13:28
S21	7	S19 ((carrier or transfer\$4 or adhesive) near2 tape)	US-PGPUB; USPAT; USOCR	AND	ON	2008/01/24 13:28
S20	1	S19 ((carrier or transfer\$4 or adhesive) near2 tape) (electrode near5 tape) (tape with peel\$3)	US-PGPUB; USPAT; USOCR	AND	ON	2008/01/24 13:28
S23	3	S19 (tape with peel\$3)	US-PGPUB; USPAT; USOCR	AND	ON	2008/01/24 13:29
S24	9	(US-20020004250-\$ or US-20060055864-\$ or US-20040256727-\$ or US-20040027811-\$).did. or	US-PGPUB; USPAT	AND	ON	2008/01/24 13:37
		(US-6378774-\$ or US-6365438-\$ or US-6064415-\$ or US-5188469-\$				
S26	4	or US-7107672-\$).did. S24 ((exfoliat\$4) near5 tape)	US-PGPUB; USPAT; USOCR	AND	ON	2008/01/24 13:38

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S25	3	S24 ((exfoliate) near5 tape)	US-PGPUB; USPAT; USOCR	AND	ON	2008/01/24 13:38
S27	1793	(electrode near5 tape) ((tape with peel\$3) or ((carrier or transfer\$4 or adhesive) near2 tape))	US-PGPUB; USPAT; USOCR	AND	ON	2008/01/24 13:46
S29	290	S18 S28	US-PGPUB; USPAT; USOCR	AND	ON	2008/01/24 13:47
S28	1503	(electrode near4 tape) ((tape with peel\$3) or ((carrier or transfer\$4 or adhesive) near2 tape))	US-PGPUB; USPAT; USOCR	AND	ON	2008/01/24 13:47
S31	. 220	S18 S30	US-PGPUB; USPAT; USOCR	AND	ON	2008/01/24 13:48
S30	1055	(electrode near3 tape) ((tape with peel\$3) or ((carrier or transfer\$4 or adhesive) near2 tape))	US-PGPUB; USPAT; USOCR	AND	ON	2008/01/24 13:48
S32 .	224	(electrode near5 tape) ((tape with peel\$3) ((carrier or transfer\$4 or adhesive) near2 tape))	US-PGPUB; USPAT; USOCR	AND	ON	2008/01/24 13:53
S33	155	(electrode near5 tape) ((tape with peel\$3) ((carrier or transfer\$4 or adhesive) near2 tape)) (cut or cutting)	US-PGPUB; USPAT; USOCR	AND	ON	2008/01/24 13:54
S35	. 1	("20050263869").PN.	US-PGPUB; USPAT; USOCR	AND	ON	2008/01/24 13:55
S34	0	("7291929").URPN.	USPAT	AND	ON	2008/01/24 13:55
S37	367	S18 S36	US-PGPUB; USPAT; USOCR	AND	ON	2008/01/24 14:07
S36	2039	(electrode near5 (adhesive adj layer or tape)) ((tape with peel\$3) or ((carrier or transfer\$4 or adhesive) near2 tape))	US-PGPUB; USPAT; USOCR	AND	ON	2008/01/24 14:07
S40	0	((adhesive adj layey) near3 (cover or adhere\$1 or attach\$3) near3 electrode) ((tape with peel\$3) or ((carrier or transfer\$4 or adhesive) near2 tape))	US-PGPUB; USPAT; USOCR	AND	ON	2008/01/24 14:11
S39	0	((adhesive adj layey) near3 (cover or adhere\$1) near3 electrode) ((tape with peel\$3) or ((carrier or transfer\$4 or adhesive) near2 tape))	US-PGPUB; USPAT; USOCR	AND	ON	2008/01/24 14:11

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S38	0	((adhesive adj layey) near2 (cover or adhere\$1) near2 electrode) ((tape with peel\$3) or ((carrier or transfer\$4 or adhesive) near2 tape))	US-PGPUB; USPAT; USOCR	AND	ON	2008/01/24 14:11
S41	0	((adhesive adj layey) near3 (cover or adhe\$4 or attach\$3) near3 (electrode or pad)) ((tape with peel\$3) or ((carrier or transfer\$4 or adhesive) near2 tape))	US-PGPUB; USPAT; USOCR	AND	ON	2008/01/24 14:12
S42	14	((exfoliat\$4) near2 (layer or sheet) near2 tape)	US-PGPUB; USPAT; USOCR	AND	ON	2008/01/24 14:46
S43	9	S24 adhesive	US-PGPUB; USPAT; USOCR	AND	ON	2008/01/24 14:51
S44	3	S24 (failure or check or checking or test or testing or measur\$5)	US-PGPUB; USPAT; USOCR	AND	ON	2008/01/24 15:48
S45	2	S24 (peel or peeling)	US-PGPUB; USPAT; USOCR	AND	ON	2008/01/24 16:55
L13	1.	9 L12	US-PGPUB; USPAT; USOCR	AND	ON	2008/01/28 08:18
L12	53	(((semiconductor or interposer) near2 (package or board)) with (cut or cutting)) ((carrier or taansfer\$4 or adhesive) near2 tape) (electrode near5 tape)	US-PGPUB; USPAT; USOCR	AND	ON	2008/01/28 08:18
L11	1	9 L10	US-PGPUB; USPAT; USOCR	AND	ON	2008/01/28 08:18
L10	54	(((semiconductor or interposer) near2 (package or board)) with ((cut or cutting) (tape))) (electrode near5 tape)	US-PGPUB; USPAT; USOCR	AND	ON	2008/01/28 08:18
L9	1982	174/255.cor. 361/736,737.cor. 375/239.cor. 29/832.cor.	US-PGPUB; USPAT; USOCR	OR	ON	2008/01/28 08:18
L15	. 1	9 L14	US-PGPUB; USPAT; USOCR	AND	ON	2008/01/28 08:19

L14	33	(((semiconductor or interposer) near2 (package or board)) with (cut or cutting)) ((carrier or transfer\$4 or adhesive) near2 tape) (electrode near5 tape) (tape with peel\$3)	US-PGPUB; USPAT; USOCR	AND	ON	2008/01/28 08:19
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